

GTS217E

N-CHANNEL ENHANCEMENT MODE POWER MOSFET

BVD _{SS}	20V
R _{DS(ON)}	22mΩ
I _D	7A

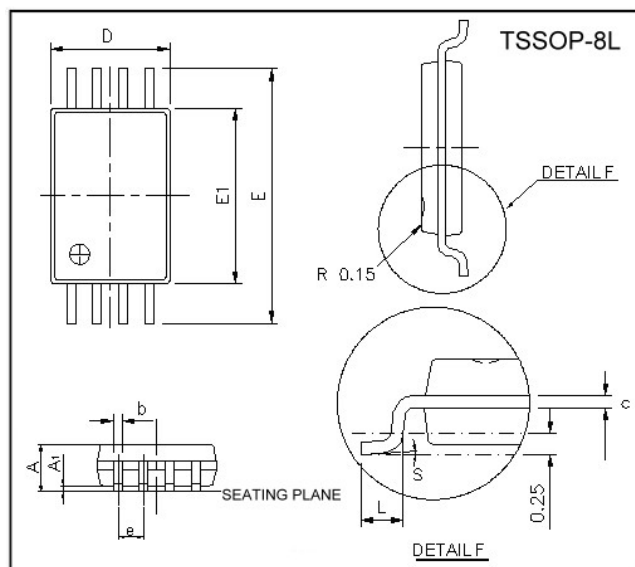
Description

The GTS217E provides the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost-effectiveness.

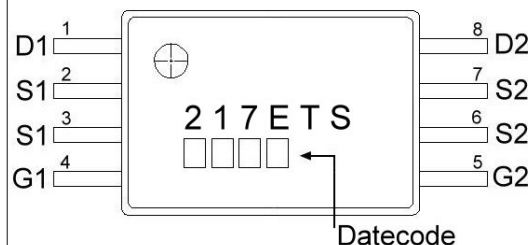
Features

- *Low on-resistance
- *Capable of 2.5V gate drive
- *Optimal DC/DC battery application

Package Dimensions



Marking:



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	-	1.20	E	6.20	6.60
A1	0.05	0.15	E1	4.30	4.50
b	0.19	0.30	e	0.65 BSC	
c	0.09	0.20	L	0.45	0.75
D	2.90	3.10	S	0°	8°

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±12	V
Continuous Drain Current ³	I _D @TA=25°C	7	A
Continuous Drain Current ³	I _D @TA=70°C	5.7	A
Pulsed Drain Current ¹	I _{DM}	30	A
Total Power Dissipation	P _D @TA=25°C	1.5	W
Linear Derating Factor		0.012	W/°C
Operating Junction and Storage Temperature Range	T _j , T _{stg}	-55 ~ +150	°C

Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-ambient ³ Max.	R _{thj-a}	83	°C/W

Electrical Characteristics (T_j = 25°C unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	V _{GS} =0, I _D =250uA
Gate Threshold Voltage	V _{GS(th)}	0.5	-	1.0	V	V _{DS} =V _{GS} , I _D =250uA
Forward Transconductance	g _{fs}	-	24	-	S	V _{DS} =5V, I _D =7A
Gate-Source Leakage Current	I _{GSS}	-	-	±10	uA	V _{GS} = ±10V
Drain-Source Leakage Current(T _j =25°C)	I _{DSS}	-	-	1	uA	V _{DS} =16V, V _{GS} =0
Drain-Source Leakage Current(T _j =55°C)		-	-	5	uA	V _{DS} =16V, V _{GS} =0
Static Drain-Source On-Resistance	R _{DS(ON)}	-	-	22	mΩ	V _{GS} =4.5V, I _D =6.6A
		-	-	30		V _{GS} =2.5V, I _D =5.5A
Total Gate Charge ²	Q _g	-	9.3	-	nC	I _D =7A V _{DS} =10V V _{GS} =4.5V
Gate-Source Charge	Q _{gs}	-	0.6	-		
Gate-Drain ("Miller") Change	Q _{gd}	-	3.6	-		
Turn-on Delay Time ²	T _{d(on)}	-	820	-	ns	V _{DS} =10V I _D =1A V _{GS} =4.5V R _G =6Ω R _L =10Ω
Rise Time	T _r	-	934	-		
Turn-off Delay Time	T _{d(off)}	-	860	-		
Fall Time	T _f	-	510	-		
Input Capacitance	C _{iss}	-	231	-	pF	V _{GS} =0V V _{DS} =10V f=1.0MHz
Output Capacitance	C _{oss}	-	164	-		
Reverse Transfer Capacitance	C _{rss}	-	137	-		

Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Forward On Voltage ²	V _{SD}	-	-	1.0	V	I _S =1.0A, V _{GS} =0V
Reverse Recovery Time ²	T _{rr}	-	15.2	-	ns	I _S =7A, V _{GS} =0V dI/dt=100A/μs
Reverse Recovery Charge	Q _{rr}	-	6.3	-	nC	
Continuous Source Current (Body Diode)	I _S	-	-	2.5	A	V _D =V _G =0V, V _S =1.0V

Notes: 1. Pulse width limited by Max. junction temperature.

2. Pulse width ≤ 300us, duty cycle ≤ 2%.

3. Surface mounted on FR4 board, t ≤ 10sec.

Characteristics Curve

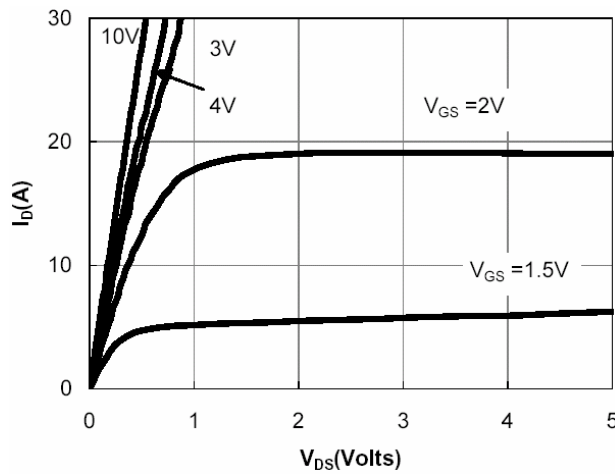


Fig 1. Typical Output Characteristics

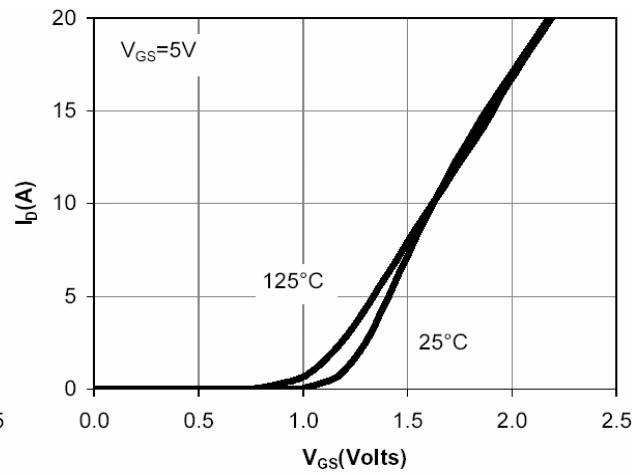


Fig 2. Transfer Characteristics

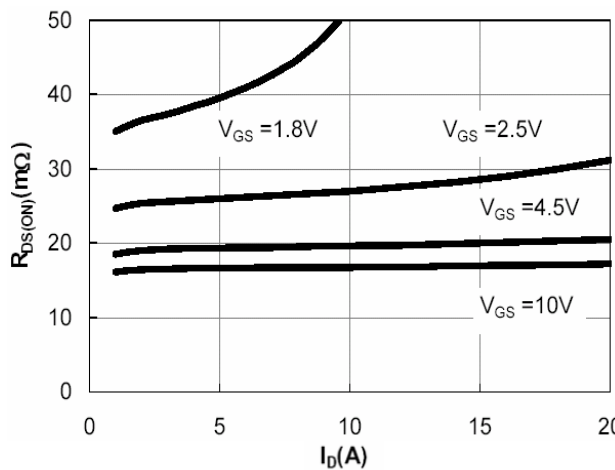


Fig 3. On-Resistance v.s. Drain Current and Gate Voltage

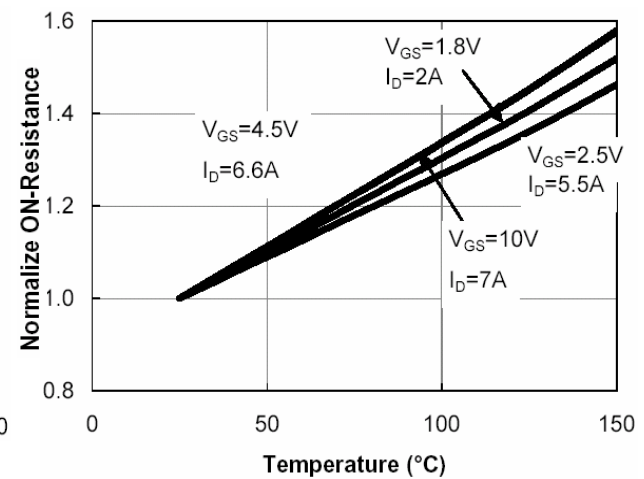


Fig 4. On-Resistance v.s. Junction Temperature

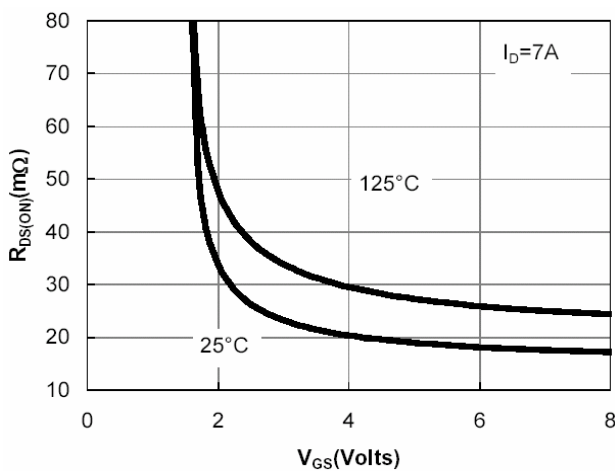


Fig 5. On-Resistance v.s. Gate-Source Voltage

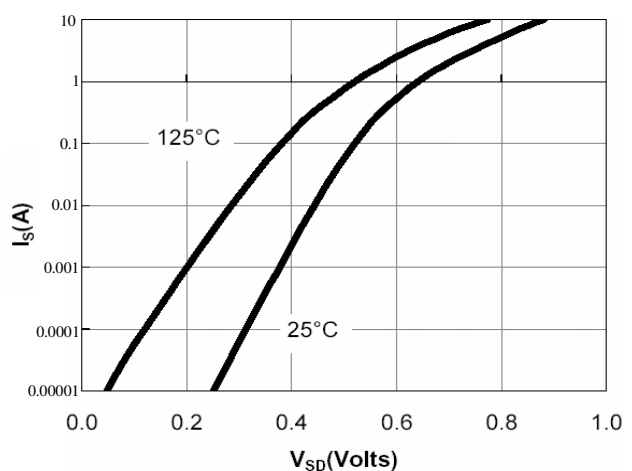


Fig 6. Body Diode Characteristics

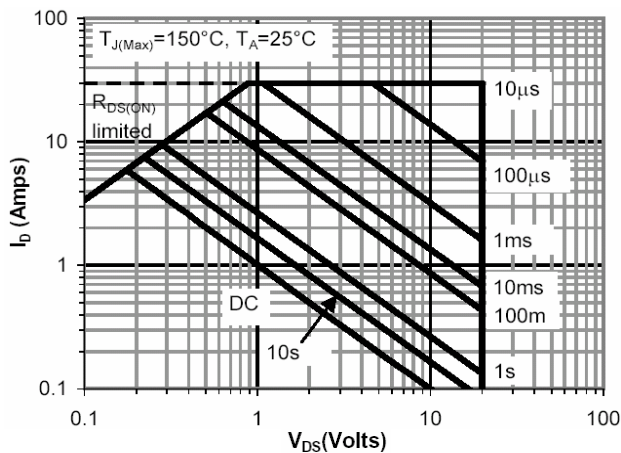
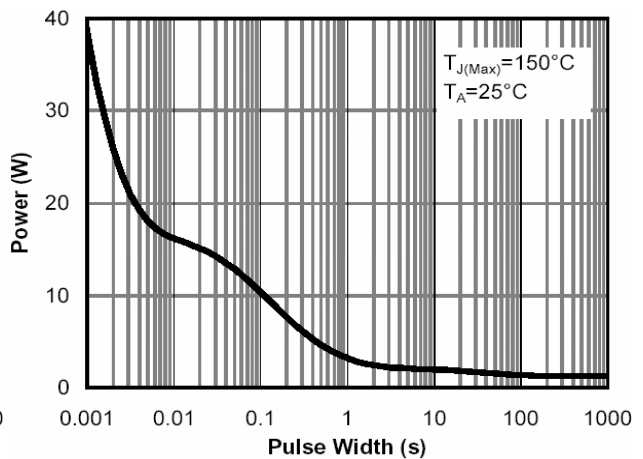


Fig 7. Maximum Safe Operating Area



**Fig 8. Single Pulse Power Rating
Junction-to-Ambient**

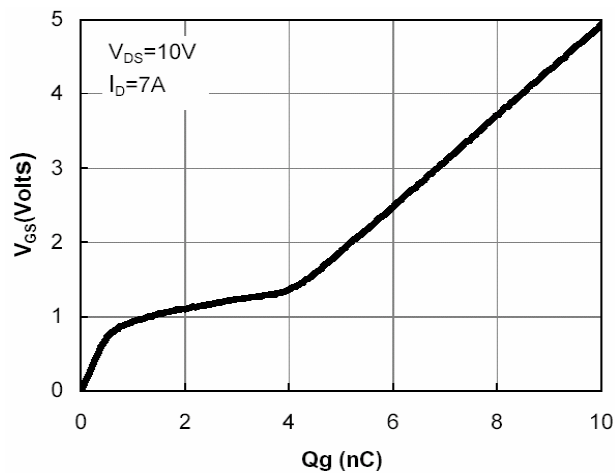


Fig 9. Gate Charge Characteristics

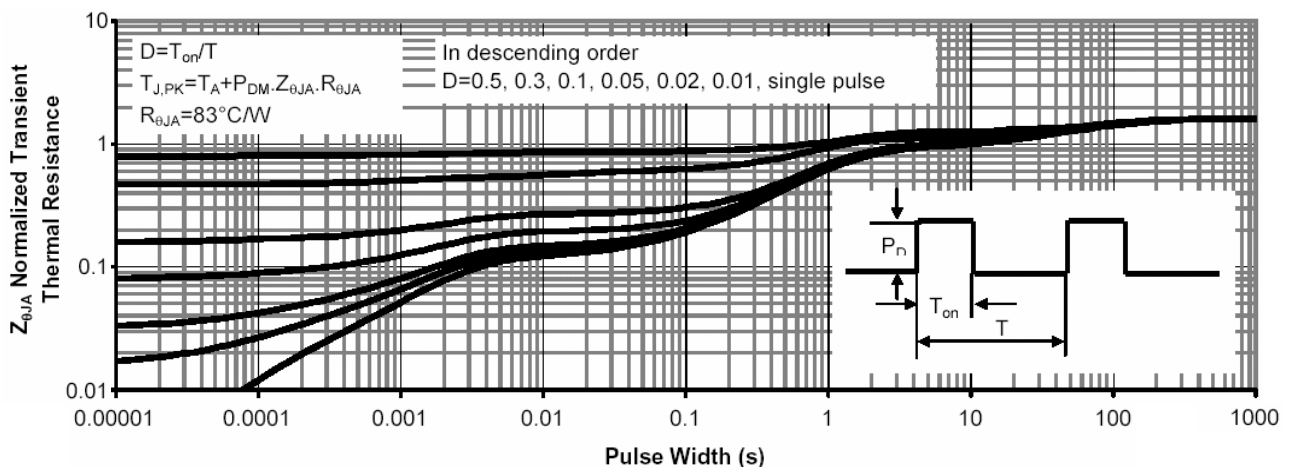


Fig 10. Normalized Maximum Transient Thermal Impedance

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